

EM-528 / EM-528B

High Tg / Very Low Loss / Halogen Free

- Applications include: high-speed server, network and telecom.
- Low Df for excellent electrical performance.
- Low CTE for X/ Y/ Z-axis direction.
- Multiple lamination and high thermal reliability applications.
- RoHS Compliant
- UL File: E150504
- Applicable IPC Slash Sheets: IPC-4103 /240, /540

Basic Laminate Property

Property	Item	Typical Value	Unit	Test Condition	IPC-TM-650	
Thermal	Tg	N/A	°C	DSC	2.4.25	
		220	°C	TMA	2.4.24	
		250	°C	DMA	2.4.24.4	
	CTE, X/Y-axis	9/10	ppm/°C	< Tg, TMA	2.4.24.5	
	CTE, Z-axis	25~30	ppm/°C	< Tg, TMA	2.4.24	
		130~150	ppm/°C	> Tg, TMA		
	Z-axis Expansion	1.4	%	50~260 °C	2.4.24	
	Td	420	°C	TGA (5%W.L)	2.4.24.6	
	T288	> 60	min.	Clad	2.4.24.1	
		> 60	min.	Etched		
Thermal Conductivity	0.6	W/m.K	-	ASTM D5470		
Electrical	Dk (R/C:50/70%)	1GHz	4.0/3.6	-	2.5.5.9	
		10GHz	3.9/3.5	-	C-24/23/50 Cavity Resonator	
		10GHz	3.9/3.5	-	SPC method	
	Df (R/C:50/70%)	1GHz	0.0047/0.0044	-	2.5.5.9	
		10GHz	0.0061/0.0058	-	C-24/23/50 Cavity Resonator	
		10GHz	0.0050/0.0046	-	SPC method	
	Volume Resistivity	> 10 ¹⁰	MΩ-cm	C-96/35/90	2.5.17.1	
Surface Resistivity	> 10 ⁹	MΩ	2.5.17.1			
Physical	Water Absorption		0.11	%	E-1/105+D-24/23 2.6.2.1	
	Peel Strength	RTF, H oz	5.0	lb/in	As Received	2.4.8
		HVLP, H oz	4.0	lb/in	As Received	
	Flexural Modulus	Warp	24~26	GPa	As Received	2.4.4
		Fill	23~25	GPa	As Received	
Flame Resistance		V-0	-	C-48/23/50	UL-94	

Above typical values are tested under specified constructions and not intended for specification.